



(社)日本半導体製造装置協会

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2006年8月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 9月度BBレシオ 10/19 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2006年8月度のBBレシオは1.16

東京 2006年9月20日 - 日本半導体製造装置協会が20日に発表した8月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**167,390**百万円(3ヶ月移動平均)、BBレシオは**1.16**だった。BBレシオ1.16は100円で販売したのに対し116円の新たな受注があったことを示す。

受注額は前月比**3.2%**減(2006年7月度確定値は**172,866**百万円)、前年同月比**42.4%**増(2005年8月度は**117,563**百万円)の**167,390**百万円だった。

販売額は前月比**8.1%**増(2006年7月度確定値は**133,481**百万円)、前年同月比**27.5%**増(2005年8月度は**113,152**百万円)の**144,313**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2006/3	158,406	156,291	0.99
2006/4	147,301	162,377	1.10
2006/5	145,589	169,170	1.16
2006/6	115,014	175,375	1.52
2006/7(確定値)	133,481	172,866	1.30
2006/8(暫定値)	144,313	167,390	1.16

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を発表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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August 2006 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. **The September Report SEAJ's Web site update** is scheduled **on Thursday, 19th October** approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **August 2006 Book-to-Bill Ratio of 1.16**

Tokyo Japan., **September 20 2006** -- JAPAN-based manufacturers of semiconductor equipment posted **¥ 167,390 million** in orders in **August 2006** (three-month average basis) and a BB Ratio of **1.16**, according to the **August 2006 BB Ratio** published today by SEAJ. A book-to-bill of **1.16** means that **¥ 116** worth of new orders was received for every ¥100 of product billed for the month.

The three-month average of worldwide bookings in **August 2006** was **¥ 167,390million**. The bookings figure is **3.2percent down the final July 2006** level of **¥ 172,866 million** and **42.4 percent up the ¥ 117,563million** in orders posted in **August 2005**.

The three-month average of worldwide billings in **August 2006** was **144,313 million**. The billings figure is **8.1percent up the final July 2006** level of **¥ 133,481 million** and **27.5percent up the August 2005** billings level of **¥ 113,152 million**.

The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill
March 2006	158,406	156,291	0.99
April 2006	147,301	162,377	1.10
May 2006	145,589	169,170	1.16
June 2006	115,014	175,375	1.52
July 2006(final)	133,481	172,866	1.30
August 2006(prim)	144,313	167,390	1.16

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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